



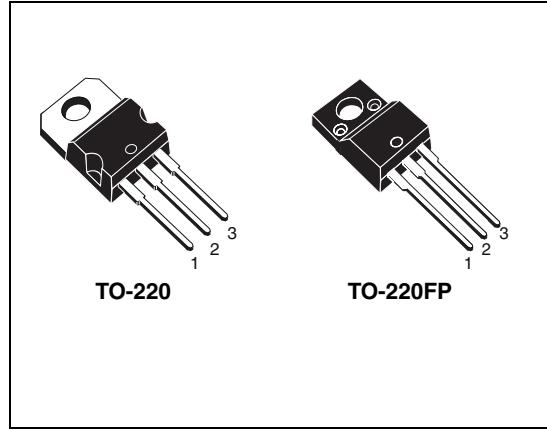
IRF630 IRF630FP

N-channel 200V - 0.35Ω - 9A TO-220/TO-220FP
Mesh overlay™ II Power MOSFET

General features

| Type | V _{DSS} | R _{DS(on)} | I _D |
|----------|------------------|---------------------|----------------|
| IRF630 | 200V | <0.40Ω | 9A |
| IRF630FP | 200V | <0.40Ω | 9A |

- Extremely high dv/dt capability
- Very low intrinsic capacitances
- Gate charge minimized



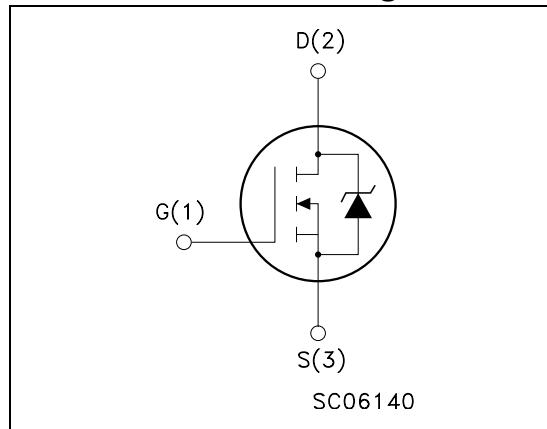
Description

This power MOSFET is designed using the company's consolidated strip layout-based MESH OVERLAY™ process. This technology matches and improves the performances compared with standard parts from various sources.

Applications

- Switching application

Internal schematic diagram



Order codes

| Part number | Marking | Package | Packaging |
|-------------|----------|----------|-----------|
| IRF630 | IRF630 | TO-220 | Tube |
| IRF630FP | IRF630FP | TO-220FP | Tube |

1 Electrical ratings

Table 1. Absolute maximum ratings

| Symbol | Parameter | Value | | Unit |
|----------------------|---|-------------------|--------------------|---------------------|
| | | TO-220 | TO-220FP | |
| V_{DS} | Drain-source voltage ($V_{GS} = 0$) | 200 | | V |
| V_{DGR} | Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$) | 200 | | V |
| V_{GS} | Gate-source voltage | ± 20 | | V |
| I_D | Drain current (continuous) at $T_C = 25^\circ\text{C}$ | 9 | 9 ⁽¹⁾ | A |
| I_D | Drain current (continuous) at $T_C = 100^\circ\text{C}$ | 5.7 | 5.7 ⁽¹⁾ | A |
| $I_{DM}^{(2)}$ | Drain current (pulsed) | 36 | 36 ⁽¹⁾ | A |
| P_{TOT} | Total dissipation at $T_C = 25^\circ\text{C}$ | 75 | 30 | W |
| | Derating factor | 0.6 | 0.24 | W/ $^\circ\text{C}$ |
| dv/dt ⁽³⁾ | Peak diode recovery voltage slope | 5 | | V/ns |
| V_{ISO} | Insulation withstand voltage (DC) | -- | 2000 | V |
| T_J T_{stg} | Operating junction temperature Storage temperature | -65 to 150 150 | | $^\circ\text{C}$ |

1. Limited only by maximum temperature allowed
2. Pulse width limited by safe operating area
3. ISD 9A, $di/dt \leq 0 \text{ A}/\mu\text{s}$, $V_{DD} \leq V(BR)_{DSS}$, $T_J \leq T_{JMAX}$

Table 2. Thermal data

| Symbol | Parameter | Value | | Unit |
|----------------|--|--------|----------|--------------------|
| | | TO-220 | TO-220FP | |
| $R_{thj-case}$ | Thermal resistance junction-case Max | 1.67 | 4.17 | $^\circ\text{C/W}$ |
| R_{thj-a} | Thermal resistance junction-ambient Max | 62.5 | | $^\circ\text{C/W}$ |
| $R_{thc-sink}$ | Thermal resistance case-sink typ | 0.5 | | $^\circ\text{C/W}$ |
| T_I | Maximum lead temperature for soldering purpose | 300 | | $^\circ\text{C}$ |

Table 3. Avalanche characteristics

| Symbol | Parameter | Value | Unit |
|----------|---|-------|------|
| I_{AR} | Avalanche current, repetitive or not-repetitive (pulse width limited by T_j Max) | 9 | A |
| E_{AS} | Single pulse avalanche energy (starting $T_j = 25^\circ\text{C}$, $I_d = I_{AR}$, $V_{DD} = 50\text{V}$) | 160 | mJ |

2 Electrical characteristics

($T_{CASE}=25^\circ\text{C}$ unless otherwise specified)

Table 4. On/off states

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|---------------------|--|---|------|------|-----------|--------------------------------|
| $V_{(BR)DSS}$ | Drain-source breakdown voltage | $I_D = 250 \mu\text{A}, V_{GS} = 0$ | 200 | | | V |
| I_{DSS} | Zero gate voltage drain current ($V_{GS} = 0$) | $V_{DS} = \text{Max rating}, V_{DS} = \text{Max rating } @ 125^\circ\text{C}$ | | | 1 50 | μA μA |
| I_{GSS} | Gate body leakage current ($V_{DS} = 0$) | $V_{GS} = \pm 20\text{V}$ | | | ± 100 | nA |
| $V_{GS(\text{th})}$ | Gate threshold voltage | $V_{DS} = V_{GS}, I_D = 250\mu\text{A}$ | 2 | 3 | 4 | V |
| $R_{DS(\text{on})}$ | Static drain-source on resistance | $V_{GS} = 10\text{V}, I_D = 4.5\text{A}$ | | 0.35 | 0.40 | Ω |

Table 5. Dynamic

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-------------------------------------|---|--|------|-----------------|------------------|----------------|
| $g_{fs}^{(1)}$ | Forward transconductance | $V_{DS} > I_{D(\text{on})} \times R_{DS(\text{on})\text{max}}, I_D = 4.5\text{A}$ | 3 | 4 | | S |
| C_{iss} C_{oss} C_{rss} | Input capacitance Output capacitance Reverse transfer capacitance | $V_{DS} = 25\text{V}, f = 1 \text{ MHz}, V_{GS} = 0$ | | 540 90 35 | 700 120 50 | pF pF pF |
| $t_{d(on)}$ t_r | Turn-on Delay Time Rise Time | $V_{DD} = 100\text{V}, I_D = 4.5\text{A}, R_G = 4.7\Omega, V_{GS} = 10\text{V}$ (see Figure 14) | | 10 15 | 14 20 | ns ns |
| Q_g Q_{gs} Q_{gd} | Total gate charge Gate-source charge Gate-drain charge | $V_{DD} = 160\text{V}, I_D = 9\text{A}$ $V_{GS} = 10\text{V}$ | | 31 7.5 9 | 45 | nC nC nC |

- Pulsed: pulse duration=300μs, duty cycle 1.5%

Table 6. Source drain diode

| Symbol | Parameter | Test conditions | Min | Typ. | Max | Unit |
|-----------------------------------|--|---|-----|-------------------|-----|--------------------|
| I_{SD} | Source-drain current | | | | 9 | A |
| $I_{SDM}^{(1)}$ | Source-drain current (pulsed) | | | | 36 | A |
| $V_{SD}^{(2)}$ | Forward on voltage | $I_{SD}=9A, V_{GS}=0$ | | | 1.5 | V |
| t_{rr} Q_{rr} I_{RRM} | Reverse recovery time Reverse recovery charge Reverse recovery current | $I_{SD}=9A,$ $di/dt = 100A/\mu s,$ $V_{DD}=50V, T_j=150^\circ C$ (see Figure 16) | | 170 0.95 11 | | ns μC A |

1. Pulse width limited by safe operating area
2. Pulsed: pulse duration=300 μs , duty cycle 1.5%

4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark.

TO-220 MECHANICAL DATA

| DIM. | mm. | | | inch | | |
|------|-------|-------|-------|-------|-------|-------|
| | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. |
| A | 4.40 | | 4.60 | 0.173 | | 0.181 |
| b | 0.61 | | 0.88 | 0.024 | | 0.034 |
| b1 | 1.15 | | 1.70 | 0.045 | | 0.066 |
| c | 0.49 | | 0.70 | 0.019 | | 0.027 |
| D | 15.25 | | 15.75 | 0.60 | | 0.620 |
| E | 10 | | 10.40 | 0.393 | | 0.409 |
| e | 2.40 | | 2.70 | 0.094 | | 0.106 |
| e1 | 4.95 | | 5.15 | 0.194 | | 0.202 |
| F | 1.23 | | 1.32 | 0.048 | | 0.052 |
| H1 | 6.20 | | 6.60 | 0.244 | | 0.256 |
| J1 | 2.40 | | 2.72 | 0.094 | | 0.107 |
| L | 13 | | 14 | 0.511 | | 0.551 |
| L1 | 3.50 | | 3.93 | 0.137 | | 0.154 |
| L20 | | 16.40 | | | 0.645 | |
| L30 | | 28.90 | | | 1.137 | |
| øP | 3.75 | | 3.85 | 0.147 | | 0.151 |
| Q | 2.65 | | 2.95 | 0.104 | | 0.116 |

